
Press Release**Research & Development**

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Peter J. Pupalais Named IEEE Fellow

Prestigious Honor Bestowed to Teledyne LeCroy Vice-President of Technology Development for Contributions to High-speed Waveform Digitizing Instruments

Chestnut Ridge, NY, January 23, 2013 — Peter J. Pupalais, Vice President of Technology Development at Teledyne LeCroy, has been named an IEEE Fellow. He is being recognized for contributions to high-speed waveform digitizing instruments. Mr. Pupalais' design efforts and inventions have provided for large increases in the performance of real-time waveform digitizers leading to the production of the world's fastest oscilloscopes. These instruments are essential to electronic engineering research and development in markets including telecommunication, semiconductor and consumer electronics, automotive, military and aerospace.

"Pete's research and development efforts have been fundamental to the fast pace of our ultra-high bandwidth product introductions and technology leadership," said Tom Reslewic, chief executive officer of Teledyne LeCroy. "We are pleased that the IEEE association has chosen to recognize his technological excellence."

The IEEE Grade of Fellow is conferred by the IEEE Board of Directors upon a person with an outstanding record of accomplishments in any of the IEEE fields of interest. The total number selected in any one year cannot exceed one-tenth of one-percent of the total voting membership. IEEE Fellow is the highest grade of membership and is recognized by the technical community as a prestigious honor and an important career achievement. 298 individuals have been elevated to IEEE Fellow for 2013.

"The IEEE Fellow elevation is a great honor", said Pupalais. "I'm especially grateful to Walter LeCroy for nominating me and am indebted to many colleagues who have supported my efforts over the years."

Mr. Pupalais has worked at Teledyne LeCroy since 1995 and currently manages integrated-circuit development, signal processing and intellectual property. Prior to Teledyne LeCroy, he served in the United States Army, consulted in embedded system design, and developed instruments at Honeywell Industrial Automation and Controls.

Mr. Pupalais has twenty-nine patents, has published numerous papers in the area of measurement instrument design, and is a member of Tau Beta Pi, Eta Kappa Nu and the IEEE signal processing, instrumentation, solid-state circuits and microwave societies. He received the B.S. degree in electrical engineering from Rutgers University, New Brunswick, New Jersey.

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About Teledyne LeCroy

Teledyne LeCroy is a leading manufacturer of advanced test instruments that drive product innovation by quickly measuring, analyzing, and verifying complex electronic signals. The Company offers high-performance oscilloscopes, protocol analyzers, and global communications protocol test solutions used by design engineers in the computer, semiconductor and consumer electronics, data storage, automotive and industrial, military and aerospace, and telecommunication markets. Teledyne LeCroy's 49-year heritage of technical innovation is the foundation for its recognized leadership in "WaveShape Analysis"—capturing, viewing, and measuring the high-speed signals that drive today's information and communications technologies. Teledyne LeCroy is headquartered in Chestnut Ridge, New York. Company information is available at teledynelecroy.com.

About IEEE

The IEEE is the world's leading professional organization for advancing technology for humanity. Through its 400,000 members in 160 countries, the IEEE is a leading authority on a wide variety of areas ranging from aerospace systems, computers and telecommunications to biomedical engineering, electric power and consumer electronics.

Dedicated to the advancement of technology, the IEEE publishes 30 percent of the world's literature in the electrical and electronics engineering and computer science fields, and has developed more than 900 active industry standards. The organization also sponsors or co-sponsors nearly 400 international technical conferences each year. If you would like to learn more about IEEE or the IEEE Fellow Program, please visit www.ieee.org.

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